

PXC-M10 Single Output Series: DC-DC Converter Module

4.5 ~ 9 VDC, 9 ~ 18 VDC, 18 ~ 36 VDC and 36~ 75 VDC input; 3.3 to 24 VDC Single Output 10 Watts Output Power



FEATURES

- SINGLE OUTPUT UP TO 2.5A
- REINFORCED INSULATION FOR 250VAC WORKING VOLTAGE
- CLEARANCE AND CREEPAGE DISTANCE :8.0mm/2MOPP
- 5000VAC INPUT TO OUTPUT 2MOPP ISOLATION
- NO MINIMUM LOAD REQUIRED
- HIGH EFFICIENCY UP TO 89%
- BUILT-IN EMI CLASS A FILTER
- 2µA PATIENT LEAKAGE CURRENT
- SMALL SIZE: 1.25×0.80×0.40 INCH
- 2:1 ULTRA WIDE INPUT VOLTAGE RANGE
- FIXED SWITCHING FREQUENCY
- INPUT UNDER-VOLTAGE PROTECTION
- OUTPUT OVER-VOLTAGE PROTECTION
- OVER-CURRENT PROTECTION
- OUTPUT SHORT CIRCUIT PROTECTION
- REMOTE ON/OFF
- COMPLIANT TO RoHS II & REACH



CE MARKED SAFETY APPROVALS:

ANSI/AAMI ES60601-1 EN60601-1 IEC60601-1

APPLICATIONS

- MEDICAL EQUIPMENT
- TELECOM/DATACOM
- INDUSTRY CONTROL SYSTEM
- MEASUREMENT EQUIPMENT
- SEMICONDUCTOR EQUIPMENT
- PV POWER SYSTEM
- IGBT GATE DRIVER

GENERAL DESCRIPTIONS

OPTIONS

- PIN CONNECTION
- REMOTE ON/OFF
- TRIM

The PXC-M10 series offer 10 watts of output power from a 1.25 x 0.80 x 0.40 inch package. PXC-M10 series have 2:1 wide input voltage of 4.5~9VDC, 9~18VDC, 18~36VDC and 36~75VDC. The PXC-M10 has features 5000VAC of isolation, short circuit protection, over-current protection and over-voltage protection. All models are particularly suited to IGBT isolated power supplies, measurement equipment, telecommunications, industrial and medical equipment applications.

Contents

Output Specifications	3
Input Specifications	4
General Specifications	5
Environmental Specifications	5
EMC Characteristics	5
Characteristic Curves	
PXC-M10-05S3P3	6
PXC-M10-05S05	8
PXC-M10-05S12	10
PXC-M10-05S15	12
PXC-M10-05S24	14
PXC-M10-12S3P3	16
PXC-M10-12S05	18
PXC-M10-12S12	20
PXC-M10-12S15	22
PXC-M10-12S24	24
PXC-M10-24S3P3	26
PXC-M10-24S05	28
PXC-M10-24S12	30
PXC-M10-24S15	32
PXC-M10-24S24	34
PXC-M10-48S3P3	36
PXC-M10-48S05	38
PXC-M10-48S12	40
PXC-M10-48S15	42
PXC-M10-48S24	44
Output Voltage Adjustment	46
Input Source Impedance	47
Output Over Current Protection	48
Output Short Circuitry Protection	48
Output Over Voltage Protection	48
Thermal Considerations	48
Remote On/off Control	49
EMS Considerations	50
Mechanical Data	51
Recommended Pad Layout	52
Soldering Considerations	52
Packaging Information	53
Part Number Structure	53
Safety and Installation Instruction	54
MTBF and Reliability	54

Application Note

Outpu	ut Specifications	5			
Parameter	Model	Min	Тур	Max	Unit
Output Voltage	xxS3P3	3.267	3.3	3.333	
(Vin(nom); Full Load; Ta=25°C)	xx S05	4.95	5	5.05	
	xxS12	11.88	12	12.12	VDC
	xxS15	14.85	15	15.15	
	xx S24	23.76	24	24.24	
Output Regulation					
Line (Vin(min) to Vin(max); Full Load)	All	-0.2		+0.2	%
Load (0% to 100% of Full Load)		-0.2		+0.2	
Output Ripple and Noise					
Peak to Peak (20MHz Bandwidth)					
With a 10µF/25V X7R MLCC	xxS3P3		30	75	
·	xx S05		30	75	
	xxS12		40	100	mVp-p
	xxS15		40	100	
	more		10	100	
With a 4.7µF/50V X7R MLCC	xx S24		50	100	
Voltage adjustability (see page 46)	xx S3P3-T	-10		+10	
(Only for B-type Pin connection option)	xx S05-<u>T</u>	-10		+10	
	xx S12-<u>T</u>	-10		+10	% of Vout
	xxS15-T	-10		+20	70 01 0001
	xx S 24- <u>T</u>	-10		+20	
Temperature Coefficient	All	-0.02		+0.02	%/°C
Output Voltage Overshoot		-0.02			/0/ 0
(Vin,min to Vin,max; Full Load; Ta=25°C)	All		0	3	% of Vout
Dynamic Load Response					
(Vin= Vin(nom); Ta=25°C)					
Load step change from					
75% to 100% or 100 to 75% of Full Load					
Peak Deviation	All		3		% of Vout
Setting Time (Vo<10% peak deviation)	All		250		μs
Output Current	xxS3P3	0	230	2500	μο
ouput current	xx S05	0		2000	
	xxS12	0		830	mA
	xxS15	0		670	
Output Ornesitense Land	xxS24	0		416	
Output Capacitance Load	xxS3P3			3000	
	xxS05			2500	_
	xxS12			430	μF
	xxS15			350	
	xxS24			125	
Output Over Voltage Protection (see page 48)	xxS3P3	3.7		5	
	xx S05	5.6		7.0	
	xx S12	13.5		16	VDC
	xx S15	18.3		22.0	
	xx S24	29.1		34.5	
Output Over Current Protection (see page 48)			150		% of El
(% of lout rated; Hiccup mode)	All		150		% of FL
Output Short Circuit Protection (see page 48)	All	C	ontinuous. au	tomatic recove	erv

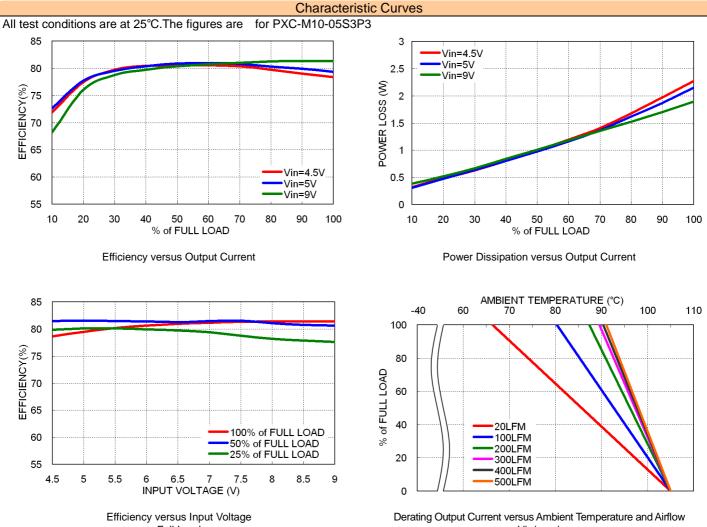
Input Specifications						
Parameter	Model	Min	Тур	Max	Unit	
Operating Input Voltage						
Continuous	05Sxx	4.5	5	9		
	12Sxx	9	12	18		
	24Sxx	18	24	36		
	48Sxx	36	48	75	VDC	
Transient (3sec,max)	05Sxx			16		
	12Sxx			25		
	24Sxx			50		
	48Sxx			100		
Input Standby Current	05S3P3		10			
(Typ. value at Vin(nom); No Load)	05S05		10			
	05S12		20			
	05S15		20			
	05S24		20			
	12S3P3		10			
	12S05		10			
	12S12		10			
	12S15		10			
	12S24		10			
	24S3P3		6		mA	
	24S05		6			
	24S12		6			
	24S15		6			
	24S24		6			
	48S3P3		4			
	48S05		4			
	48S12		4			
	48S15		4			
	48S24		4			
Under Voltage Lockout Turn-on Threshold	05Sxx		-	4.5		
	12Sxx			9		
	24Sxx			18	VDC	
	48Sxx			36		
Under Voltage Lockout Turn-off Threshold	05Sxx		4			
-	12Sxx		8			
	24Sxx		16		VDC	
	48Sxx		33			
Input reflected ripple current	All		20		mAp-p	
(5 to 20MHz, 12µH source impedance)			20			
Start Up Time						
(Vin(nom) and constant resistive load)	All				ms	
Power up			30		1115	
Remote ON/OFF			30			
Remote ON/OFF Control Type B (see page 49)						
(The Ctrl pin voltage is referenced to negative input)	xxSxx-P					
Ctrl pin Low Voltage, Module ON	AAUAA- <u>F</u>		Short or 0			
Ctrl pin High Voltage, Module OFF			Open or 2.	2 ~ 12VDC	1	
Input Current of Remote Control Pin		-0.5		1	mA	
Remote Off State Input Current			2.5		mA	

General Specifications								
Parameter	Model	Min	Тур	Max	Unit			
Efficiency	05S3P3		80					
(Vin(nom); Full Load; Ta=25°C)	05S05		84					
	05S12		86.5					
	05S15		87					
	05S24		85.5					
	12S3P3	83						
	12S05	85.5						
	12S12		88					
	12S15		89					
	12S24		89		%			
	24S3P3		83		70			
	24S05		86.5					
	24S12		89 89					
	24S15							
	24S24		89					
	48S3P3		82.5					
	48S05		86.5					
	48S12	89						
	48S15		89					
	48S24		88.5					
Isolation voltage (1 minute)	All				VAC			
Input to Output		5000						
Isolation capacitance	All		12	17	pF			
Leakage current (240VAC,60Hz)	All			2	μA			
Switching Frequency	All	270	300	330	kHz			
Clearance/Creepage	All	8			mm			
Weight	All	14.0			g			
MTBF(see page 54)	All				hours			
MIL-HDBK-217F Ta=25°C, Full load		3.849 X 10°						
				ANSI/AAMI ES60601-1				
		IEC60601-1, EN60601-1						
Case Material				e black plastic				
Base Material	All		Non-conductiv					
Potting Material	All		Silicone (l	JL94 V-0)				

Environmental Specifications						
Parameter	Model	Min	Тур	Max	Unit	
Operating Ambient Temperature						
Without Derating	All	-40		77	°C	
With Derating		77		105		
Storage Temperature	All	-55		125	°C	
Thermal Impedance (20LFM)	All		18		°C/W	
Relative humidity	All	5		95	% RH	
Thermal Shock	All	MIL-STD-810F				
Vibration	All	MIL-STD-810F				

EMC Characteristics						
Characteristic	Standard	Con	Level			
EMI	EN55011					
	EN55022	Module st	Class A			
	FCC Part 18					
	EN55011					
	EN55022	With external input filter		Class B		
	FCC Part 18					
ESD	EN61000-4-2	Air	±8kV	Perf. Criteria A		
		Contact	±6kV	Ten. Ontena A		
Radiated Immunity	EN61000-4-3		10V/m	Perf. Criteria A		
Fast Transient(see page 50)	EN61000-4-4		±2kV	Perf. Criteria A		
Surge(see page 50)	EN61000-4-5		±2kV	Perf. Criteria A		
Conducted Immunity	EN61000-4-6		10V r.m.s	Perf. Criteria A		

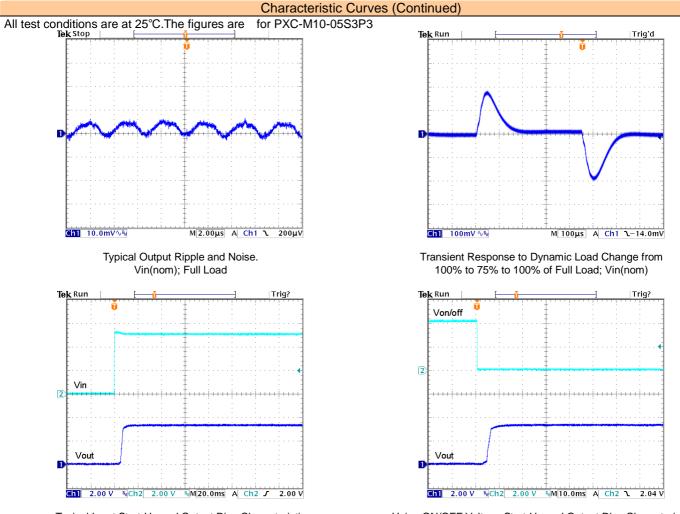
PXC-M10-SINGLE



Full Load

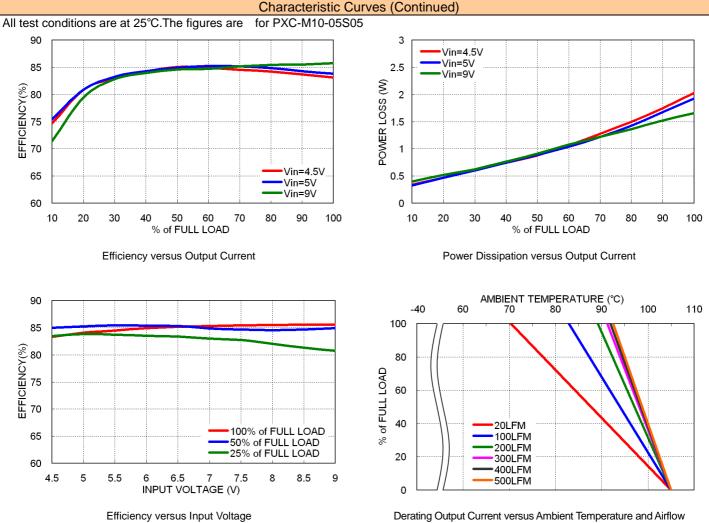
Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

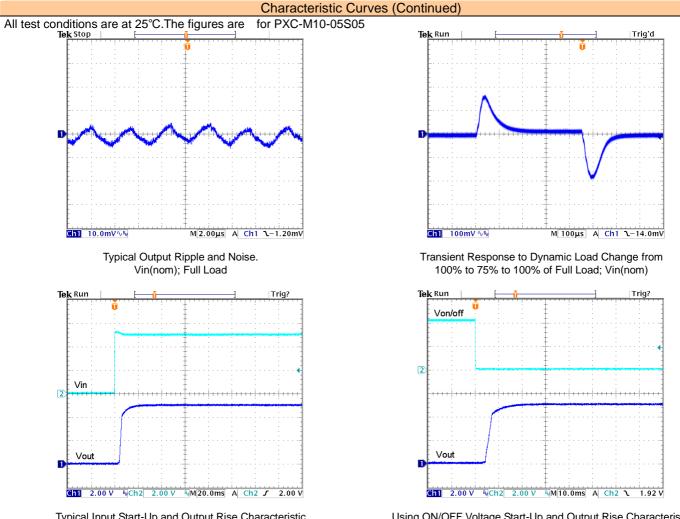
PXC-M10-SINGLE



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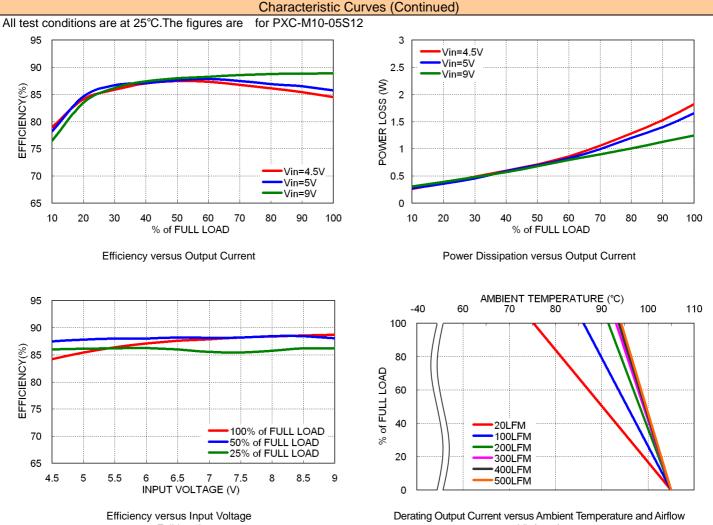
erating Output Current versus Ambient Temperature and Airflow Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

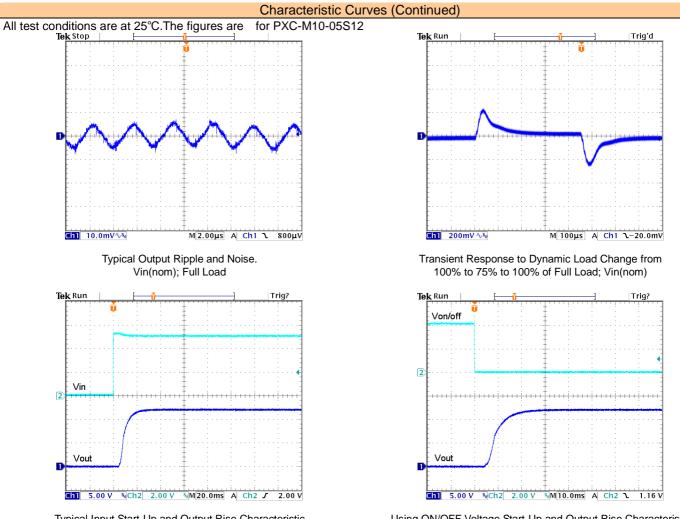
PXC-M10-SINGLE



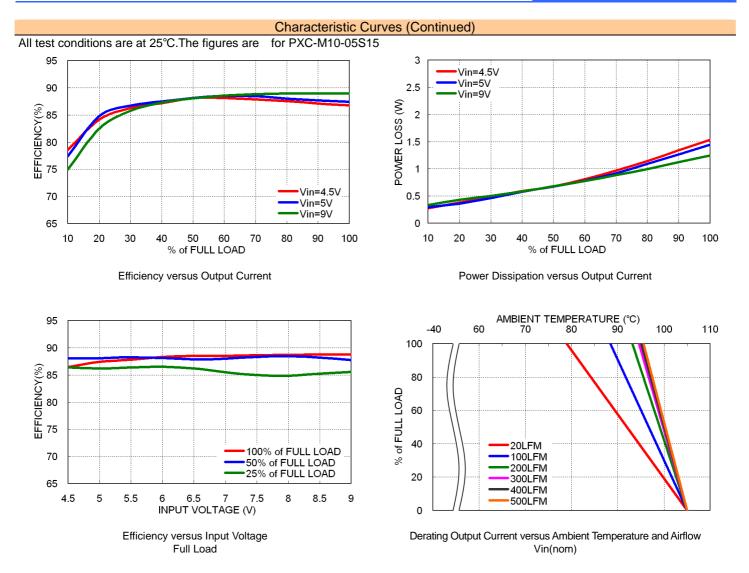
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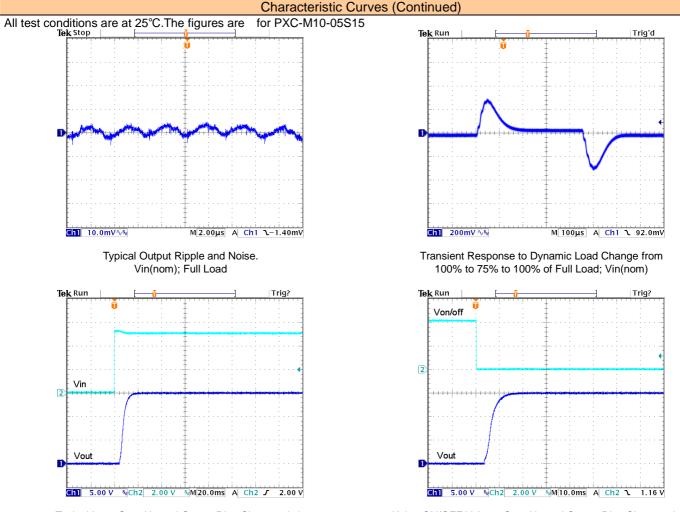
Vin(nom)

PXC-M10-SINGLE

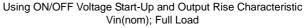


Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

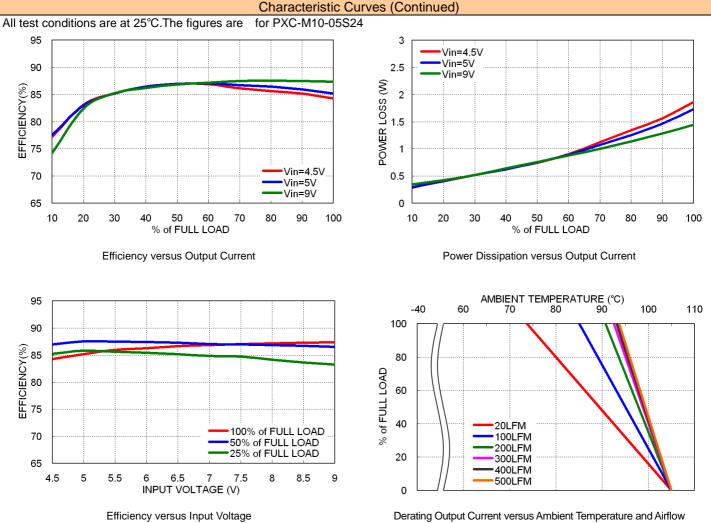




Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



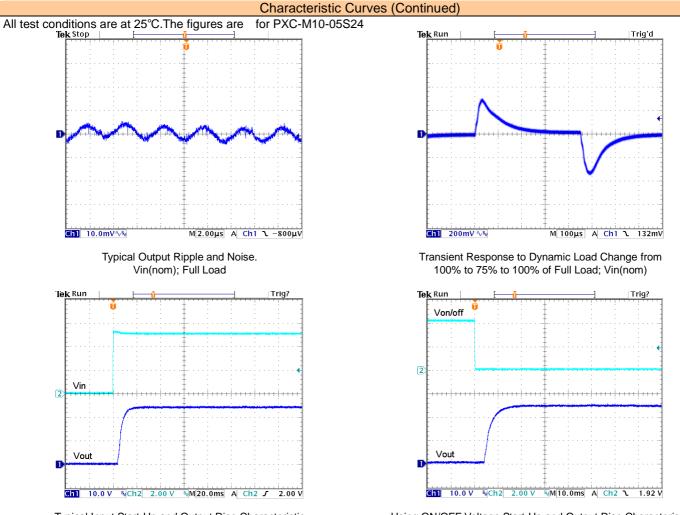
PXC-M10-SINGLE



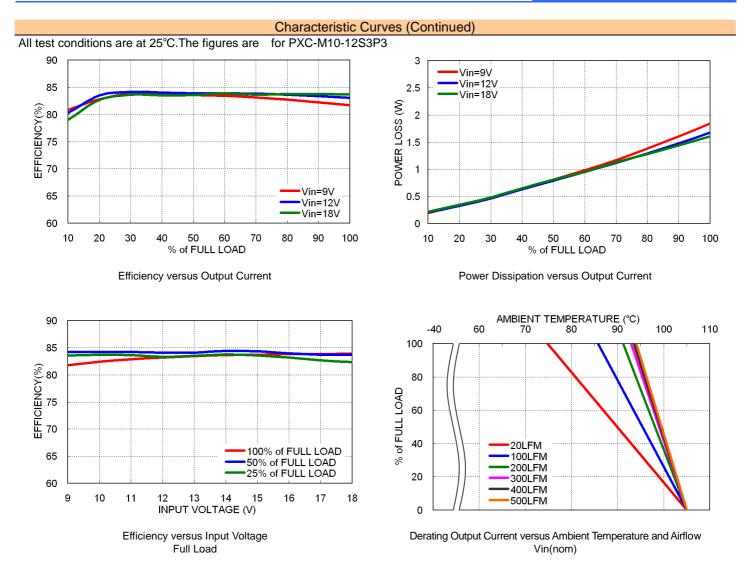
Full Load

Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

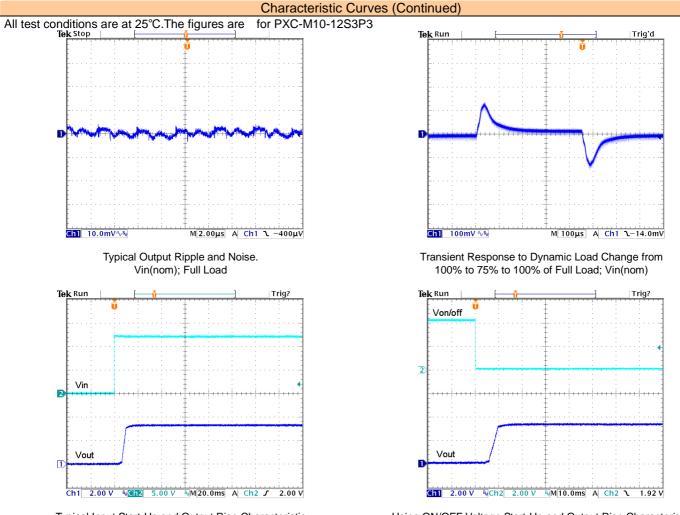
PXC-M10-SINGLE



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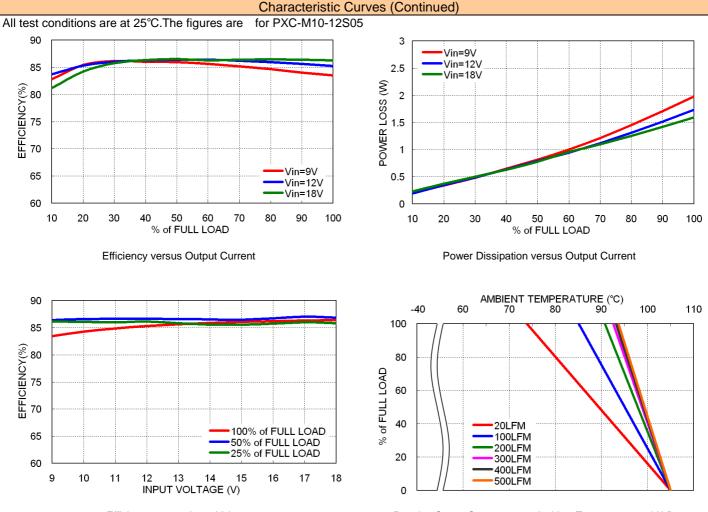


PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

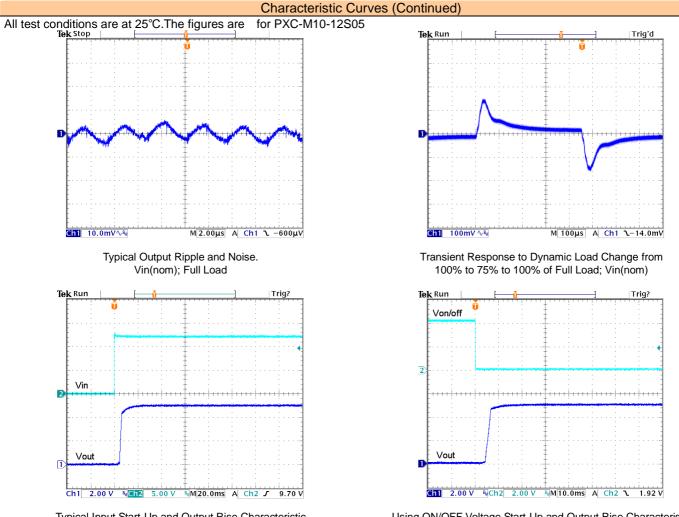
PXC-M10-SINGLE



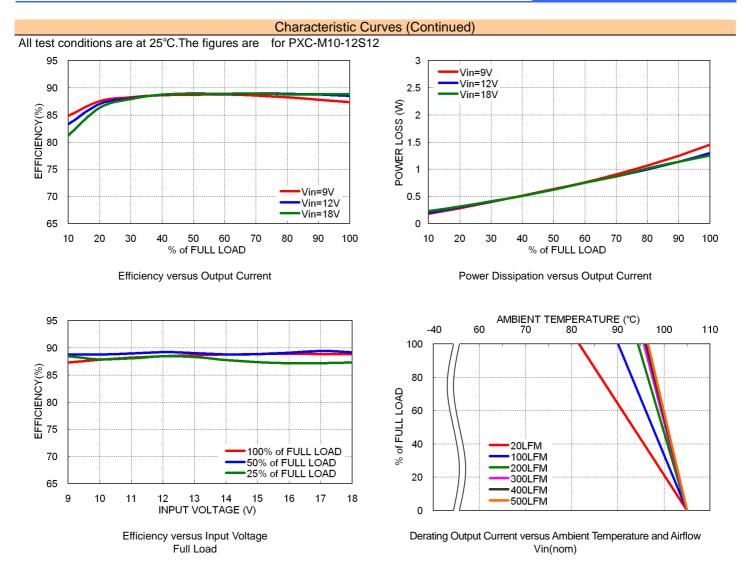
Efficiency versus Input Voltage Full Load

Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

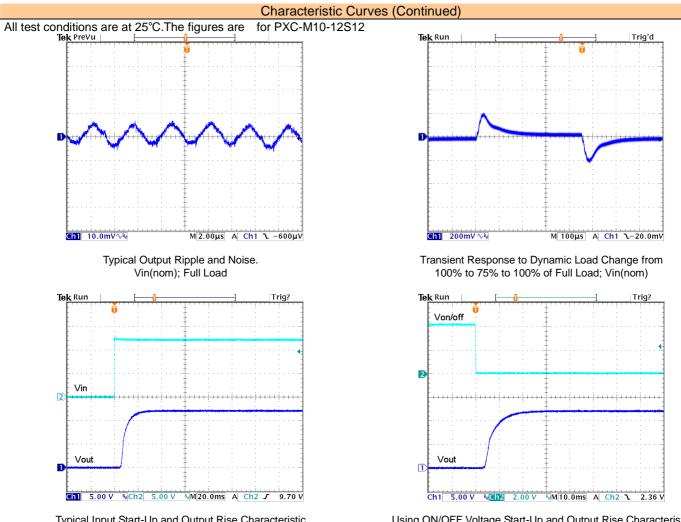
PXC-M10-SINGLE



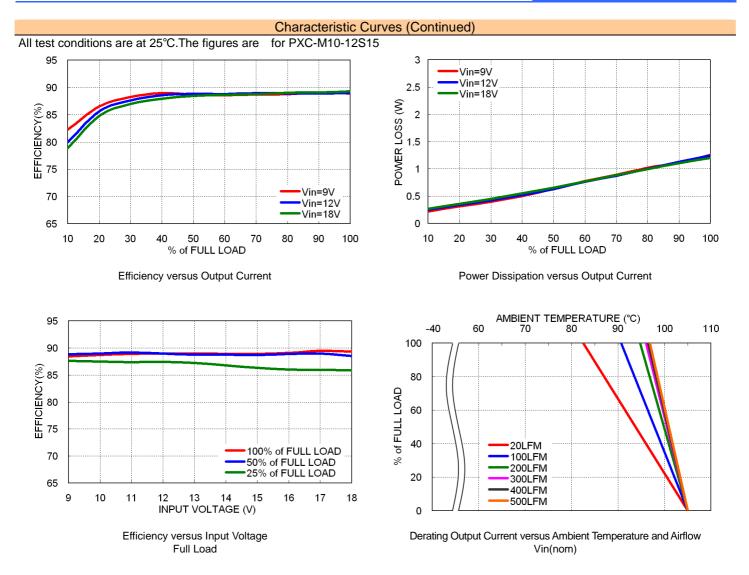
Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



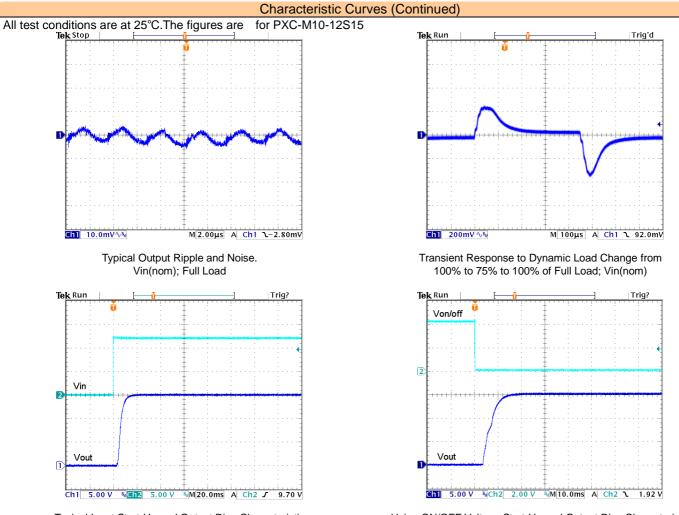
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Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

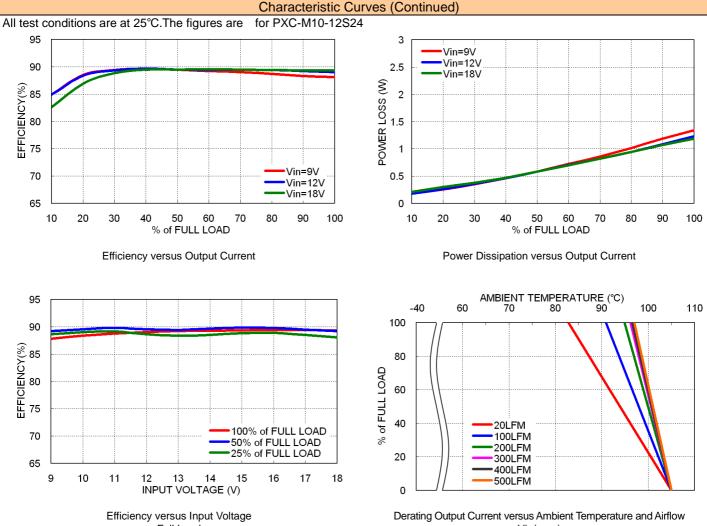


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Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

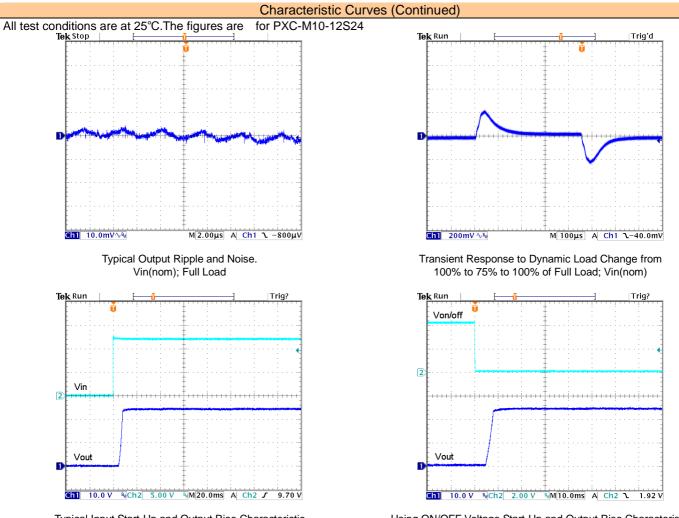
PXC-M10-SINGLE



Full Load

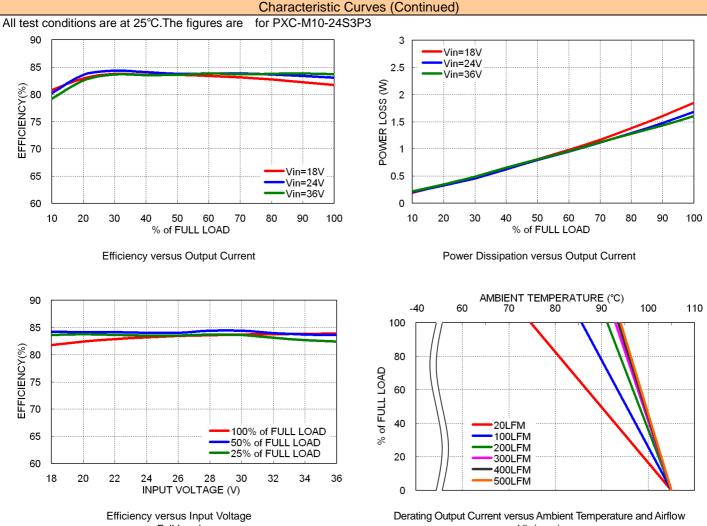
Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

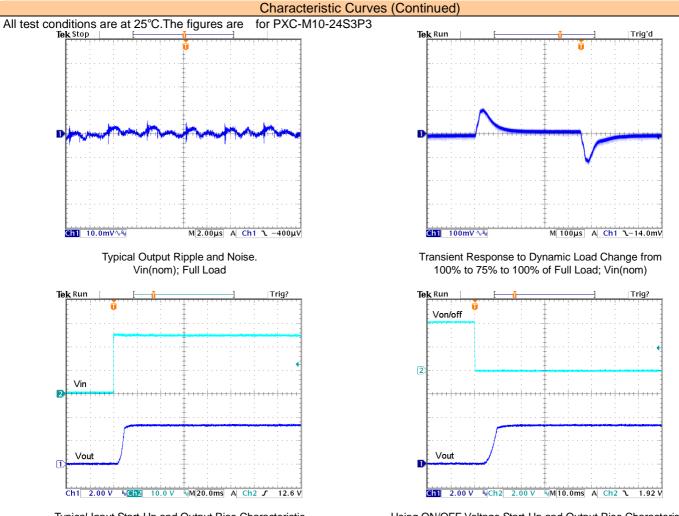
PXC-M10-SINGLE



Full Load

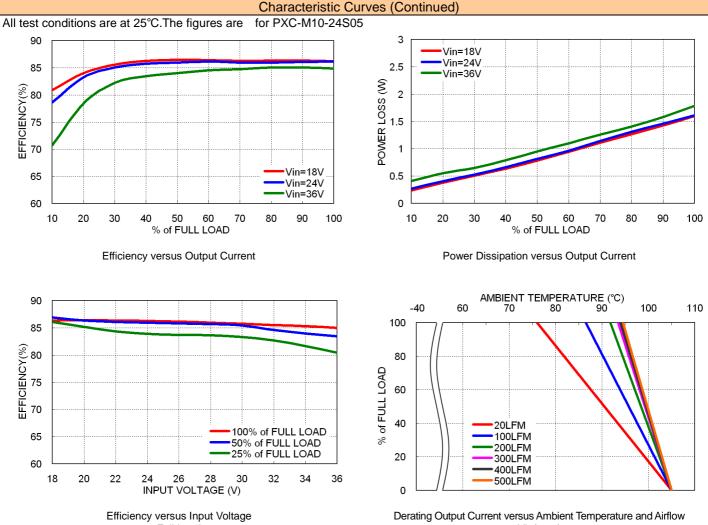
Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

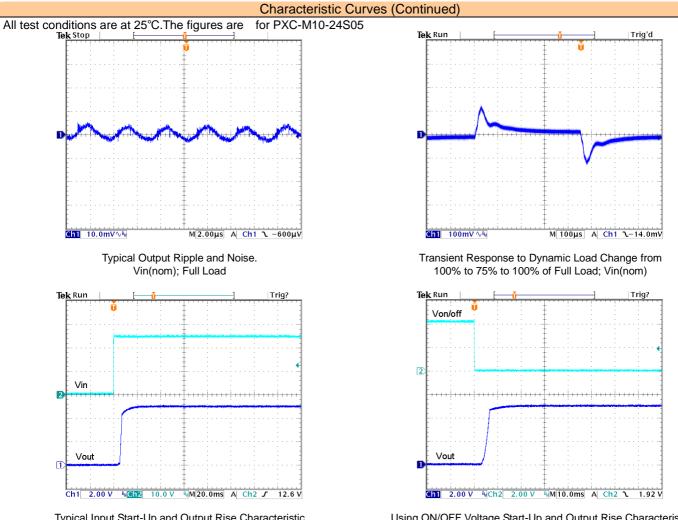
PXC-M10-SINGLE



Full Load

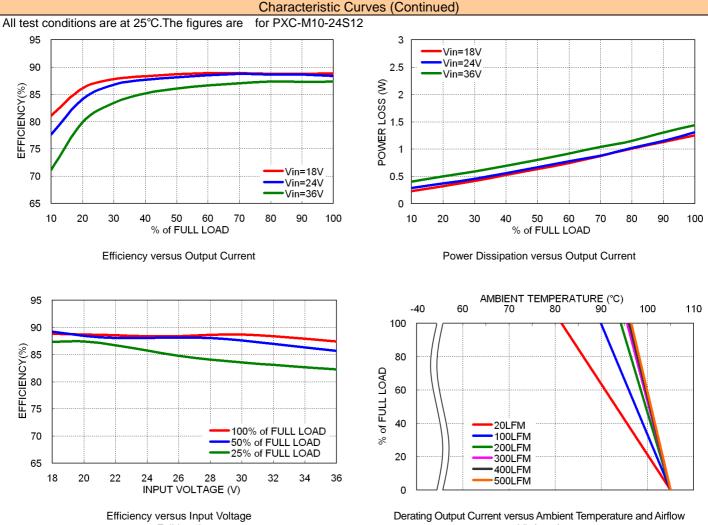
Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

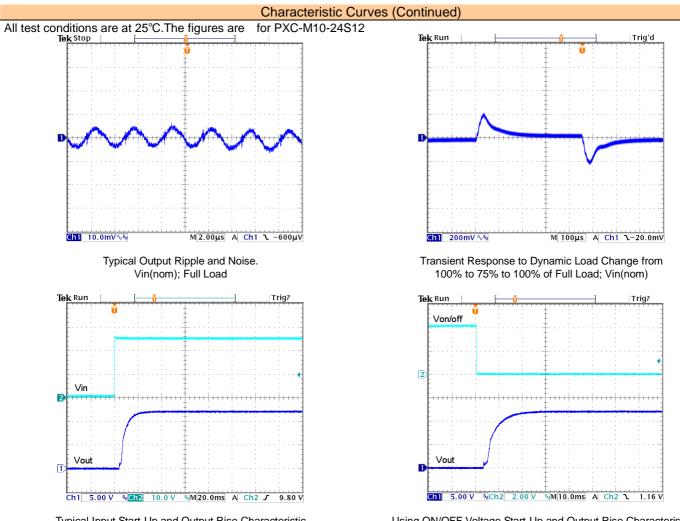
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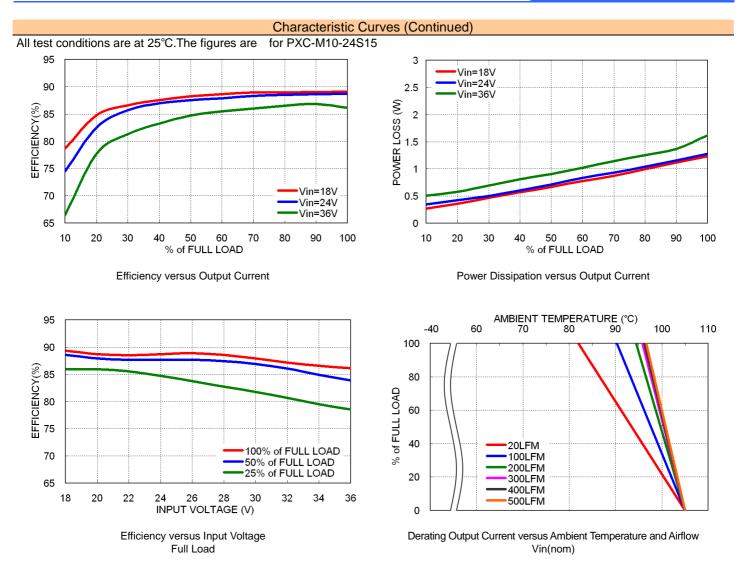
Full Load

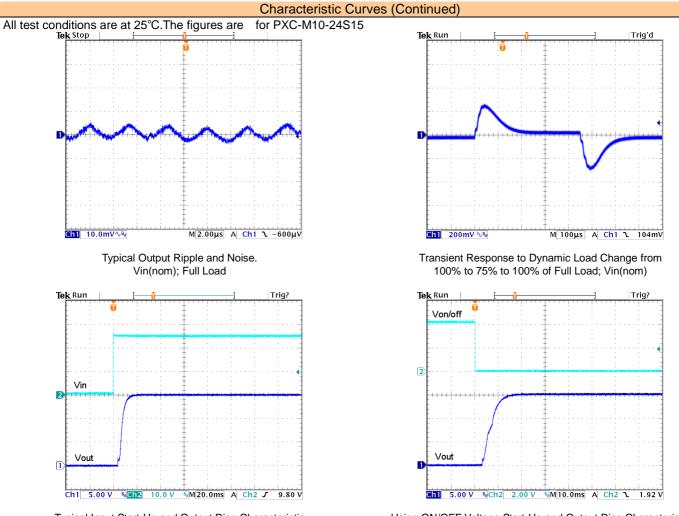
Vin(nom)

PXC-M10-SINGLE

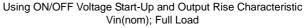


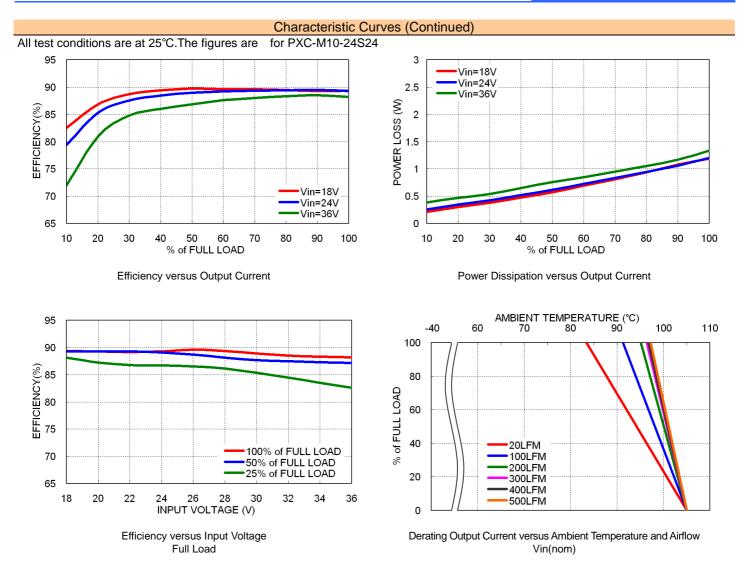
Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



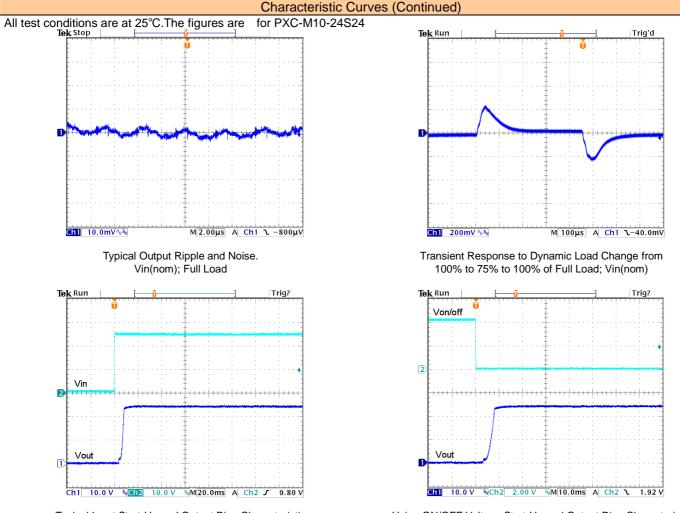


Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



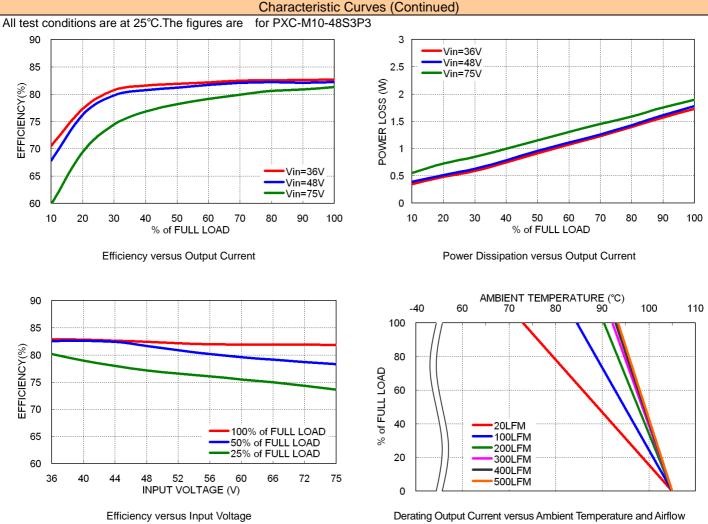


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Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

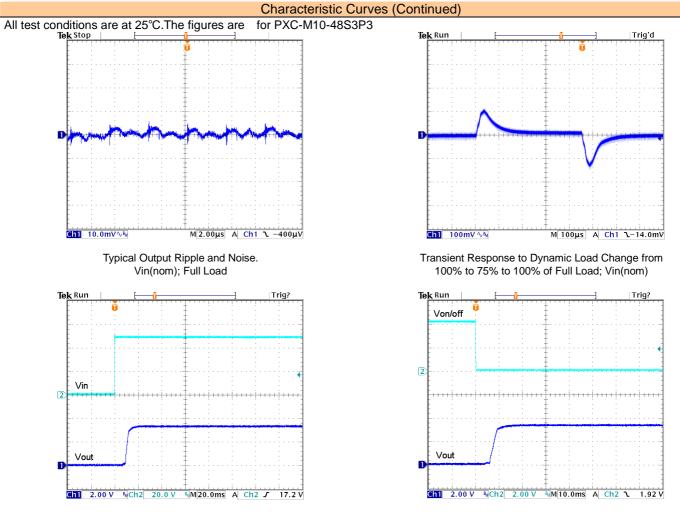
PXC-M10-SINGLE



Full Load

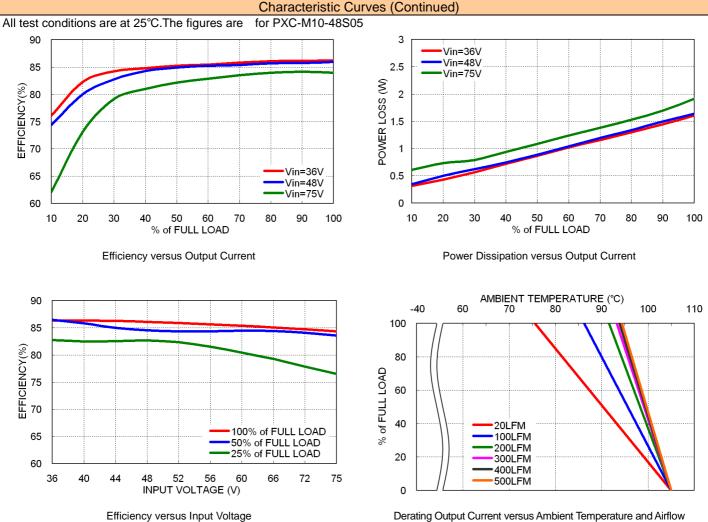
erating Output Current versus Ambient Temperature and Airflow Vin(nom)

PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

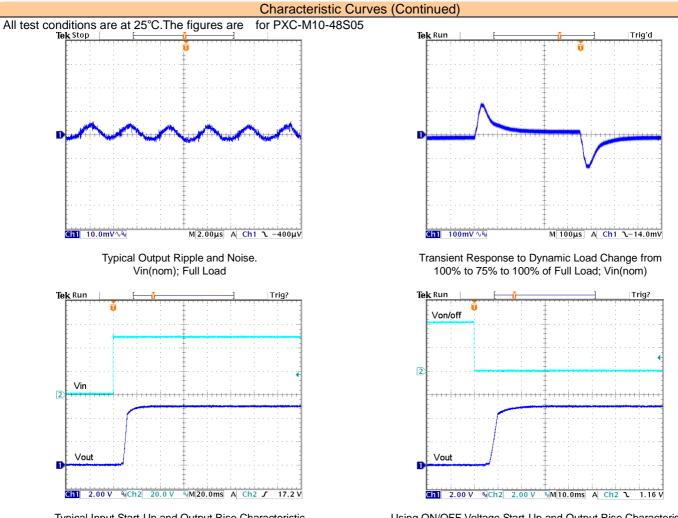
PXC-M10-SINGLE



Full Load

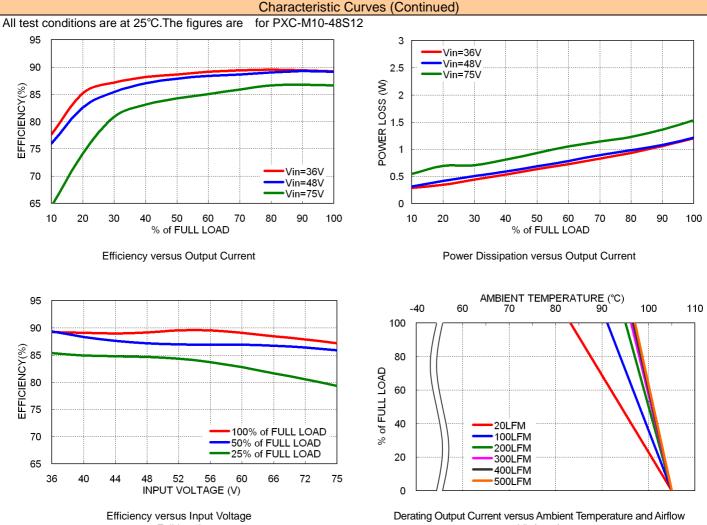
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PXC-M10-SINGLE



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

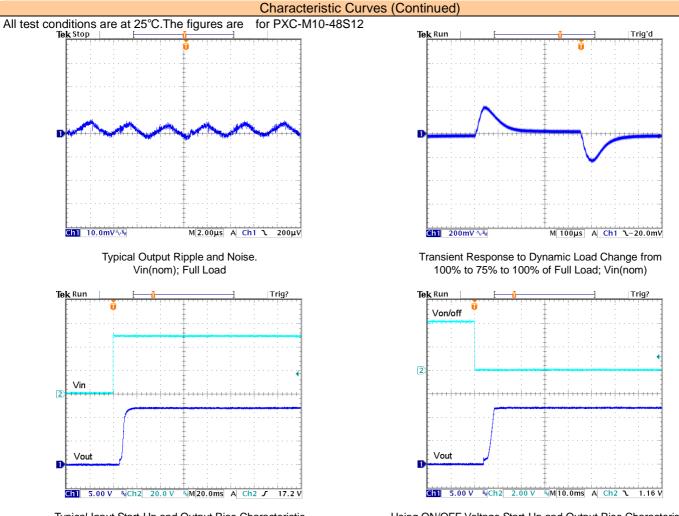
PXC-M10-SINGLE



Full Load

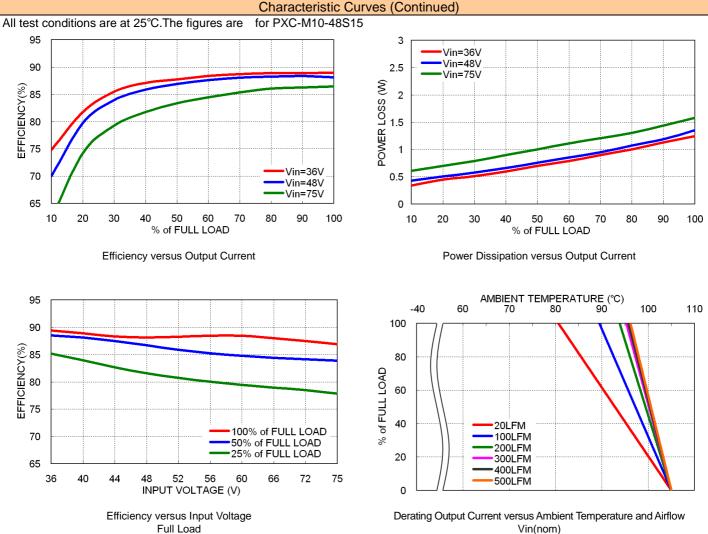
Vin(nom)

PXC-M10-SINGLE



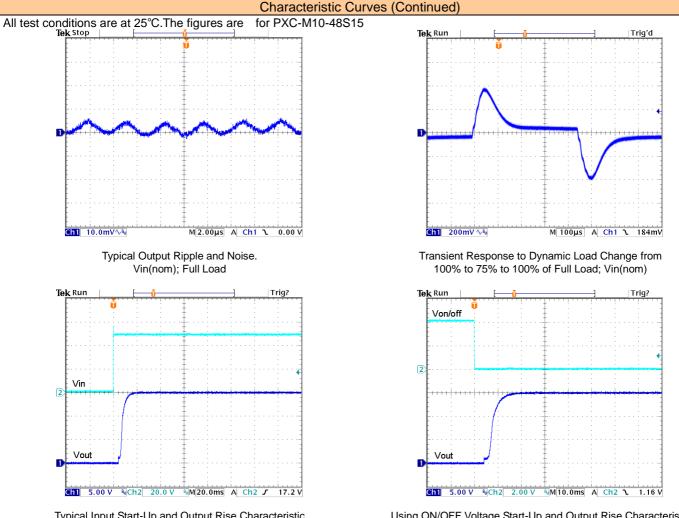
Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

PXC-M10-SINGLE



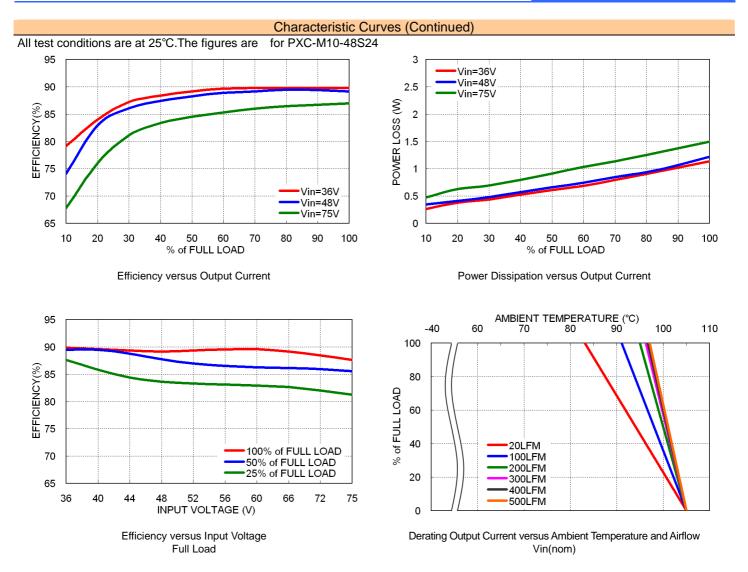
Vin(nom)

PXC-M10-SINGLE

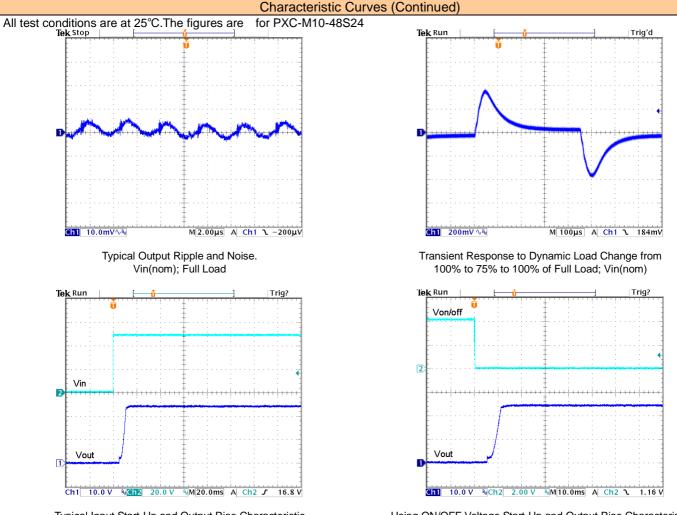


Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

PXC-M10-SINGLE



PXC-M10-SINGLE

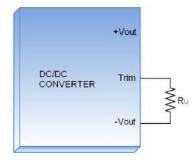


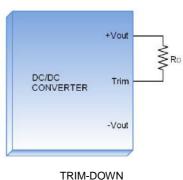
Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

Output Voltage Adjustment

Output voltage adjustment is an optional function for PXC-M10-xxSxx-xT.

It allows the user to increase or decrease the output voltage of the module. This is accomplished by connecting an external resistor between the TRIM pin and either the +Vout or -Vout pins. With an external resistor between the TRIM and -OUTPUT pin, the output voltage increases. With an external resistor between the TRIM and +OUTPUT pin, the output voltage decreases. The external TRIM resistor needs to be at least 1/16W of rated power.





TRIM-UP

Output voltage adjustment configurations

TRIM TABLE

xxS3P3	B-xT	TRIN	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	3.333	3.366	3.399	3.432	3.465	3.498	3.531	3.564	3.597	3.630
RU	(kΩ)	385.837	191.894	127.246	94.922	75.527	62.598	53.362	46.436	41.049	36.739

		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	3.267	3.234	3.201	3.168	3.135	3.102	3.069	3.036	3.003	2.970
RD	(kΩ)	114.963	53.906	33.554	23.378	17.273	13.202	10.295	8.114	6.418	5.061

xx S05	-xT	TRIM	I-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	5.048	5.098	5.148	5.198	5.248	5.298	5.348	5.398	5.448	5.498
RU	(kΩ)	252.301	125.126	82.734	61.538	48.820	40.342	34.286	29.744	26.211	23.385

		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	4.948	4.898	4.848	4.798	4.748	4.698	4.648	4.598	4.548	4.498
RD	(kΩ)	248.499	120.674	78.066	56.762	43.980	35.458	29.371	24.806	21.255	18.415

xxS12	-xT	TRIM	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	12.121	12.241	12.361	12.481	12.601	12.721	12.841	12.961	13.081	13.201
RU	(kΩ)	202.645	98.772	64.148	46.836	36.449	29.524	24.578	20.868	17.983	15.674

		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	11.881	11.761	11.641	11.521	11.401	11.281	11.161	11.041	10.921	10.801
RD	(kΩ)	777.155	381.028	248.985	182.964	143.351	116.943	98.079	83.932	72.928	64.126

xxS15	-xT	TRIM	1-UP								
Trim-Up	(%)	2	4	6	8	10	12	14	16	18	20
Vout	(V)	15.305	15.605	15.905	16.205	16.505	16.806	17.106	17.406	17.706	18.006
RU	(kΩ)	77.962	36.431	22.587	15.665	11.512	8.744	6.766	5.283	4.129	3.206

		TRIM-I	DOWN								
Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	14.855	14.705	14.555	14.405	14.255	14.105	13.955	13.805	13.654	13.504
RD	(kΩ)	818.776	401.838	262.859	193.369	151.675	123.879	104.025	89.135	77.553	68.288

(kΩ)

488.645

432.880

Output Voltage Adjustment (Continued)

TRIM TABLE (Continued)

RD

	xx S24-	хT	TRIM	/I-UP								
	Trim-Up	(%)	2	4	6	8	10	12	14	16	18	20
	Vout	(V)	24.484	24.964	25.444	25.924	26.404	26.884	27.364	27.844	28.324	28.804
	RU	(kΩ)	277.598	132.299	83.866	59.650	45.120	35.433	28.514	23.325	19.289	16.060
-												
			TRIM-I	DOWN								
	Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
	Vout	(V)	23.764	23.524	23.283	23.043	22.803	22.563	22.323	22.083	21.843	21.603

934.761

767.467

647.972

558.350

Input Source Impedance

1185.701

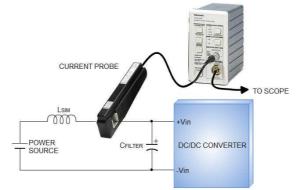
The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Install choke (LSIM) to simulate the impedance of power source. External input capacitors CFILTER serve primarily as energy-storage elements, minimizing line voltage variations caused by transient IR drops in conductors from backplane to the DC/DC. The capacitor must as close as possible to the input terminals of the power module for lower impedance. The input reflected-ripple current measurement configuration is shown below:

Input reflected-ripple current measurement setup

2440.402

1603.934

4949.803



PXC-M10-05Sxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	100µF	50V	Nippon chemi-con KY-series

PXC-M10-12Sxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	47µF	100V	Nippon chemi-con KY-series

PXC-M10-24Sxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	47µF	100V	Nippon chemi-con KY-series

PXC-M10-48Sxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	47µF	100V	Nippon chemi-con KY-series

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Output Over Current Protection

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150 percent of rated current for PXC-M10 SERIES.

Hiccup-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to restart when the fault is removed. There are other ways of protecting the power supply when it is over-loaded, such as the maximum current limiting or current fold-back methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the power supply for a given time and then tries to start up the power supply again. If the over-load condition has been removed, the power supply will start up and operate normally; otherwise, the controller will see another over-current event and shut off the power supply again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

The hiccup operation can be done in various ways. For example, one can start hiccup operation any time an over-current event is detected; or prohibit hiccup during a designated start-up is usually larger than during normal operation and it is easier for an over-current event is detected; or prohibit hiccup during a designated start-up interval (usually a few milliseconds). The reason for the latter operation is that during start-up, the power supply needs to provide extra current to charge up the output capacitor. Thus the current demand during start-up is usually larger than during normal operation and it is easier for an over-current event to occur. If the power supply starts to hiccup once there is an over-current, it might never start up successfully. Hiccup mode protection will give the best protection for a power supply against over current situations, since it will limit the average current to the load at a low level, so reducing power dissipation and case temperature in the power devices.

Output Short Circuitry Protection

Continuous and auto-recovery mode.

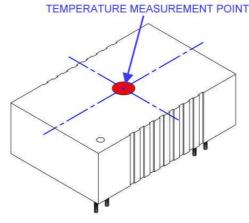
During short circuit, converter still shut down. The average current during this condition will be very low and the device can be safety in this condition.

Output Over Voltage Protection

The output over-voltage protection consists of circuitry that internally clamps the output voltage. If a more accurate output over-voltage protection scheme is required then this should be implemented externally via use of the remote on/off pin.

Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although the maximum point temperature of the power modules is 105°C, limiting this temperature to a lower value enhances the reliability.



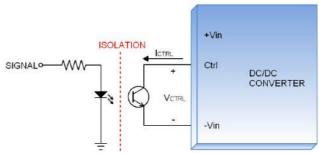


Remote On/off Control

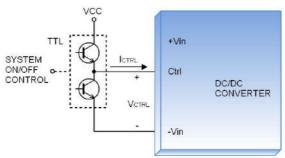
Only for B-type pin connection option with suffix -P,. Ex.: PXC-M10-24S05-P

The module is ON during logic Low and turns OFF during logic High. The Ctrl pin is an open collector/drain logic input signal that is referenced to (-)Vin. If not using the remote on/off feature, the Ctrl and (-)Vin pins should be connected together (shorted) or apply 0-1.2V between these two pins for the module to be ON.

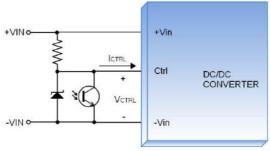
Remote ON/OFF Implementation



Isolated-Control Remote ON/OFF



Level Control Using TTL Output

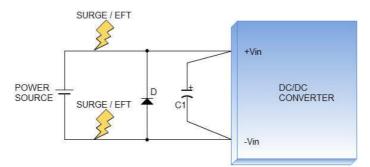


Level Control Using Line Voltage



EMS Considerations

The PXC-M10 series can meet Fast Transient EN61000-4-4 and Surge EN61000-4-5 performance criteria A with external components connected to the input terminals of the module. Please see the following schematic:



SURGE / Fast Transient

PXC-M10-05SXX			
Component	Value	Voltage	Reference
D	10A	45V	Vishay V10P45
C1	1000µF	25V	Nippon chemi-con KY-series

PXC-M10-12Sxx			
Component	Value	Voltage	Reference
C1	470µF	50V	Nippon chemi-con KY-series

PXC-M10-24Sxx			
Component	Value	Voltage	Reference
C1	470µF	50V	Nippon chemi-con KY-series

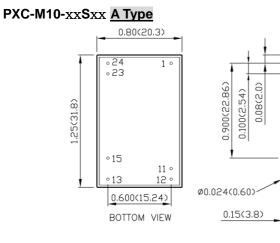
PXC-M10-48Sxx

Component	Value	Voltage	Reference
C1	330µF	100V	Nippon chemi-con KY-series

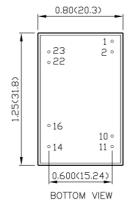
PXC-M10-SINGLE

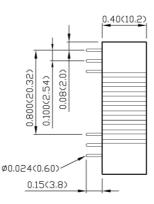
Mechanical Data

0.40(10.2)



PXC-M10-xxSxx B Type





PIN CONNECTION

PIN	FUNCTION
1	+ Vin
11	No pin
12	-Vout
13	+Vout
15	No pin
23	- Vin
24	- Vin

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5)

X.XXX±0.01 (X.XX±0.25) Pin pitch tolerance ±0.01 (0.25)

Pin pitch tolerance ±0.01 (0.25)
Pin dimension tolerance ±0.004 (0.1)

PIN CONNECTION

FUNCTION				
Ctrl (Option) / No pin*				
- Vin				
Trim (Option) / No pin*				
No pin / NC**				
+Vout				
-Vout				
+Vin				
+Vin				

* If no Ctrl or Trim option, there is

no pin on the corresponding pin number.

** Pin 11 is "No pin" for

PXC-M10-xxSxx<u>B-T</u> PXC-M10-xxSxx<u>B</u>-P<u>T</u> Pin 11 is "NC" for PXC-M10-xxSxx<u>B</u> PXC-M10-xxSxx<u>B</u>-P

1. All dimensions in Inch (mm)

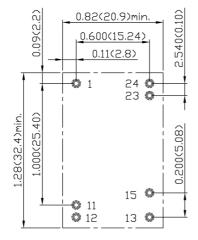
- 2. Tolerance: X.XX±0.02 (X.X±0.5)
- X.XXX±0.01 (X.XX±0.25) 3. Pin pitch tolerance ±0.01 (0.25)
- 4. Pin dimension tolerance ± 0.004 (0.1)

PXC-M10-SINGLE

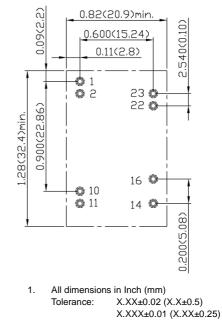
Recommended Pad Layout

PXC-M10-xxSxx A Type

Lead free wave solder profile



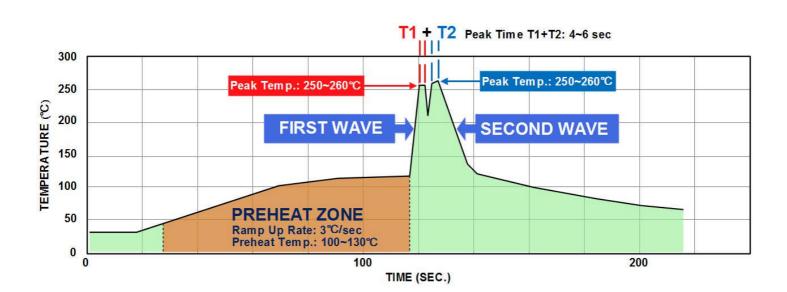
PXC-M10-xxSxx B Type



2. Pin pitch tolerance ± 0.01 (0.25)

3. Pin dimension tolerance ±0.004 (0.1)

Soldering Considerations



Reference Solder : Sn-Ag-Cu ; Sn-Cu Hand Soldering (Reference) : Soldering iron : Power 150W Soldering Time : 3~6 sec Temp : 410~430°C

52



Packaging Information

Tube

10pcs converters in a Tube All dimensions in inches (mm)

Part Number Structure							
PXC-M10	-	48	S	05	A	- P	Т
Series Name		Input Voltage (VDC)	Output Quantity	Output Voltage (VDC)	Pin Connection Option	Remote On/Off Option	Trim Option
	-	05: 4.5~9 12: 9~18 24: 18~36 48: 36~75	S:Single	3P3: 3.3 05: 5 12: 12 15: 15 24: 24	A : A type □: B type	No On/Off control Remote On/Off (Only for B type Pin connection)	I: No Trim Trim (Only for B type Pin connection)
			D: Dual	05: ±5 12: ±12 15: ±15			

Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current @ No Load	Efficiency	Maximum Capacitor Load
	VDC	VDC	mA	mA	%	μF
PXC-M10-05S3P3A/0		3.3	2500	10	80	3000
PXC-M10-05S05A/0		5	2000	10	84	2500
PXC-M10-05S12A/□	4.5 ~ 9	12	830	15	86.5	430
PXC-M10-05S15A/□		15	670	15	87	350
PXC-M10-05S24A/0		24	416	20	85.5	125
PXC-M10-12S3P3A/		3.3	2500	10	83	3000
PXC-M10-12S05A/D		5	2000	10	85.5	2500
PXC-M10-12S12A/D	9 ~ 18	12	830	10	88	430
PXC-M10-12S15A/0		15	670	10	89	350
PXC-M10-12S24A/D		24	416	10	89	125
PXC-M10-24S3P3A/0		3.3	2500	6	83	3000
PXC-M10-24S05A/0		5	2000	6	86.5	2500
PXC-M10-24S12A/0	18 ~ 36	12	830	6	89	430
PXC-M10-24S15A/□		15	670	6	89	350
PXC-M10-24S24A/D		24	416	6	89	125
PXC-M10-48S3P3A/D		3.3	2500	4	82.5	3000
PXC-M10-48S05A/D		5	2000	4	86.5	2500
PXC-M10-48S12A/□	36 ~ 75	12	830	4	89	430
PXC-M10-48S15A/□		15	670	4	89	350
PXC-M10-48S24A/□		24	416	4	88.5	125

Safety and Installation Instructions

Fusing Consideration

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. See suggested values below:

Model	Fuse Rating (A)	Fuse Type
PXC-M10-05Sxx	5	Slow-Blow
PXC-M10-12Sxx	2	Slow-Blow
PXC-M10-24Sxx	1	Slow-Blow
PXC-M10-48Sxx	0.5	Slow-Blow

Based on the information provided in this data sheet on inrush energy and maximum dc input current at low Vin.

The MTBF has been calculated using:

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 3.849×10⁶ hours.

MTBF and Reliability